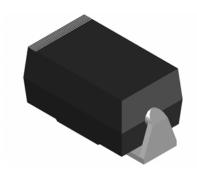




Plastic High Voltage Rectifier





Features

- VR 2KV
- IO 0.5A
- Glass passivated chip junction
- High surge current capability

Mechanical Data

- Package: SMA-W Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	EM520AG
Device marking code			EM520AG
Maximum Repetitive peak reverse voltage	V_{RRM}	V	2000
Maximum RMS Voltage	V _{RMS}	V	1400
Maximum DC Blocking Voltage	V _{DC}	V	2000
Average rectified output current @ 60Hz sine wave, Resistance load, Ta=50°C (FIG.1)	Io	А	0.5
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C		А	20
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C	- I _{FSM}		40
Current squared time @1ms≤t≤8.3ms Tj=25°C	l²t	A ² s	1.66
Storage temperature	T _{stg}	°C	-55 ~ +150
Junction temperature	Tj	°C	-55 ~ +150

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	EM520AG
Maximum instantaneous forward voltage	V _F	>	I _{FM} =0.5A	2
Maximum DC reverse current	I _R	μА	Tj =25℃	5
at rated DC blocking voltage			Tj =125°C	50
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	4.5

EM520AG

■Ordering Information (Example)

PREFERED	P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
EM520A	G	F1	Approximate 0.067	5000	1	80000	Reel

■Thermal Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	EM520AG
Typical Thermal Resistance	$R_{\theta J-A}$	°C/W	65 ¹⁾

Note

■ Characteristics (Typical)

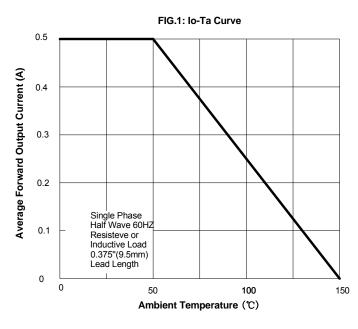


FIG.2: Forward Surge Current Capability

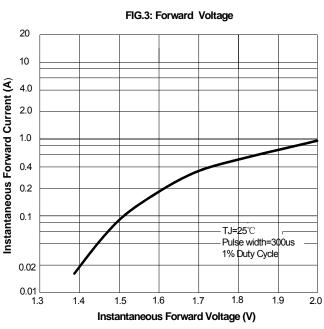
25

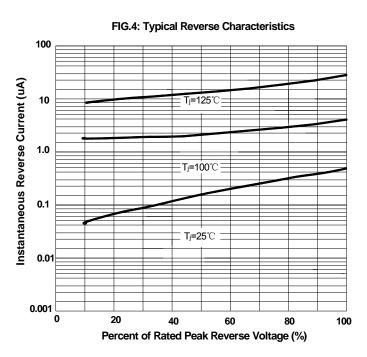
8.3ms Single Half Sine Wave JEDEC Method

15

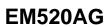
10

1 2 4 6 8 10 20 40 60 80 100 Number of Cycles



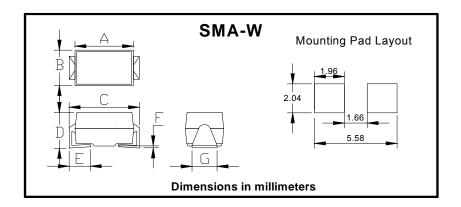


⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas





■ Outline Dimensions



SMA-W					
Dim	Min	Max			
Α	4.00	4.60			
В	2.40	2.65			
С	4.80	5.31			
D	2.05	2.45			
Е	0.80	1.50			
F	0.10	0.20			
G	1.15	1.80			



EM520AG

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